

<p style="text-align: center;">U.S. Department of Commerce INFORMATION DISCLOSURE CITATION IN AN APPLICATION (Use several sheets if necessary)</p>	ATTY. DOCKET NO. DKC 1720.01	SERIAL NO.: 10 731 757
	APPLICANT: YANG ET AL	
	FILING DATE: DECEMBER 8 2003	GROUP: 1712
	O P E MAP 25 2005	

U.S. PATENT DOCUMENTS

EXAMINER INITIALS	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
DR	4 883 835	11/28/89	Buyesch et al.	524	504	
	4 983 658	1/8/91	Kress et al.	524	141	
/	6 437 029	8/20/02	Lim et al.	524	97	
/	6 576 161	6/10/03	Lim et al.	252	609	
	6 630 524	10/7/03	Lim et al.	524	100	
↓	6 797 754	9/28/04	Yang et al.	—	—	
	10 480 180	12/8/03	Yang et al.			
	10 480 056	12/8/03	Yang et al.			

FOREIGN PATENT DOCUMENTS

EXAMINER INITIALS	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
DR	1994-0014647	7/19/94	Korea	—	—		X
	8-208884	8/13/96	Japan	—	—		X
/	7-76649	3/2/95	Japan	—	—		X
↓	EP 0 728 811 A2	8/28/96	Europe	—	—	X	

EXAMINER INITIALS	OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)
DR	<p>Abstract of Korean Patent Application Laid-open No. 94-14647, July 19, 1994</p> <p>Abstract of Japanese Patent Laid-open No. 8-208884, August 13, 1996</p> <p>Abstract of Japanese Patent Laid-open No. 7-76649, March 2, 1995</p> <p>Abstract of EP0936244, August 18, 1999</p>

EXAMINER	DATE CONSIDERED
Dave Butten	5/16/05

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.